

CGHV40180F 180 W, DC - 2000 MHz, 50 V, GaN HEMT

Cree's CGHV40180F is an unmatched, gallium nitride (GaN) high electron mobility transistor (HEMT). The CGHV40180F, operating from a 50 volt rail, offers a general purpose, broadband solution to a variety of RF and microwave applications. GaN HEMTs offer high efficiency, high gain and wide bandwidth capabilities making the CGHV40180F ideal for linear and compressed amplifier circuits. The transistor is available in a 2-lead flange package.



Package Types: 440223 PN: CGHV40180F

Typical Performance Over 800 MHz - 1000 MHz (Te = 25°C), 50 V

Parameter	800 MHz	850 MHz	900 MHz	950 MHz	1000 MHz	Units
Small Signal Gain	25.6	25.2	24.9	24.4	24.3	dB
Gain @ Pin 34 dBm	20.4	20.8	20.3	20.1	20.1	dB
Output Power @ Pin 34 dBm	275	302	279	257	257	W
EFF @ Pin 34 dBm	67	75	73	73	71	%

Note:

Measured CW in the CGHV40180F-AMP Application circuit.



FEATURES

- Up to 2000 MHz Operation
- 24 dB Small Signal Gain at 900 MHz
- 20 dB Power Gain at 900 MHz
- 250 W Typical Output Power at 900 MHz
- 75 % Efficiency at P_{SAT}

APPLICATIONS

- Military Communications
- Public Safety VHF-UHF applications

Large Signal Models Available for ADS and MWO

- Radar
- Medical
- Broadband Amplifiers

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Absolute Maximum Ratings (not simultaneous) at 25°C Case Temperature

Parameter	Symbol	Rating	Units	Conditions
Drain-Source Voltage	V _{DSS}	125	Volts	25°C
Gate-to-Source Voltage	V _{GS}	-10, +2	Volts	25°C
Storage Temperature	T _{stg}	-65, +150	°C	
Operating Junction Temperature ¹	TJ	225	°C	
Maximum Forward Gate Current	I _{GMAX}	42	mA	25°C
Maximum Drain Current ¹	I _{DMAX}	12.1	А	25°C
Soldering Temperature ²	Τ _s	245	°C	
Screw Torque	τ	40	in-oz	
CGHV40180F Thermal Resistance, Junction to Case	R _{eJC}	0.95	°C/W	P _{DISS} = 150, 85°C
Maximum dissipated power		150	W	P _{DISS} = 150, 85°C
Case Operating Temperature ³	T _c	-40, +150	°C	

Note:

¹ Current limit for long term, reliable operation

² Refer to the Application Note on soldering at <u>www.cree.com/RF/Document-Library</u>

³See also, Power Derating Curve on Page 5.

Electrical Characteristics

Characteristics	Symbol	Min.	Тур.	Max.	Units	Conditions
DC Characteristics ¹ (T _c = 25°C)						
Gate Threshold Voltage	$V_{\rm GS(th)}$	-3.8	-3.0	-2.3	V _{DC}	$V_{_{\mathrm{DS}}}$ = 10 V, I $_{_{\mathrm{D}}}$ = 20.8 mA
Gate Quiescent Voltage	$V_{_{GS(Q)}}$	-	-2.7	-	V _{DC}	$V_{_{\mathrm{DS}}}$ = 50 V, I $_{_{\mathrm{D}}}$ = 1000 mA
Saturated Drain Current ²	I _{DS}	31.4	37.6	-	А	$V_{\rm DS}$ = 6.0 V, $V_{\rm GS}$ = 2.0 V
Drain-Source Breakdown Voltage	V _{BR}	150	-	-	V _{DC}	$V_{_{\rm GS}}$ = -8 V, I $_{_{\rm D}}$ = 41.8 mA
RF Characteristics ^{2,3} ($T_c = 25^{\circ}C$, $F_0 = 900$ M	IHz unless other	wise noted)				
Small Signal Gain	G _{ss}	23.4	24.0	-	dB	$V_{_{DD}}$ = 50 V, $I_{_{DQ}}$ = 1.0 A, $P_{_{in}}$ =10dBm CW
Power Gain	G _P	19.3	20.3	-	dB	$V_{_{\rm DD}}$ = 50 V, $I_{_{\rm DQ}}$ = 1.0 A, $P_{_{\rm in}}$ =34 dBm CW
Power Output at Saturation	P _{out}	53.7	54.3	-	dBm	$V_{_{DD}}$ = 50 V, $I_{_{DQ}}$ = 1.0 A, $P_{_{in}}$ =34 dBm CW
Drain Efficiency ⁴	η	64	74	-	%	$V_{_{ m DD}}$ = 50 V, $I_{_{ m DQ}}$ = 1.0 A, $P_{_{ m in}}$ =34 dBm CW
Output Mismatch Stress	VSWR	-	-	3:1	Ψ	No damage at all phase angles, $V_{_{DD}}$ = 50 V, $I_{_{DQ}}$ = 1.0 A, $P_{_{OUT}}$ = 180 W CW
Dynamic Characteristics						
Input Capacitance	C _{GS}	-	57.8	-	pF	$V^{}_{\rm DS}$ = 50 V, $V^{}_{\rm gs}$ = -8 V, f = 1 MHz
Output Capacitance	C _{DS}	-	13.7	-	pF	$V_{_{DS}}$ = 50 V, $V_{_{gs}}$ = -8 V, f = 1 MHz
Feedback Capacitance	C_{gd}	-	1.23	-	pF	$V_{_{DS}}$ = 50 V, $V_{_{gs}}$ = -8 V, f = 1 MHz

Notes:

¹ Measured on wafer prior to packaging.

² Scaled from PCM data.

³ Measurements are to be performed using Cree production test fixture AD-838292F-TB

⁴ Drain Efficiency = P_{out}/PDC

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CGHV40180F Typical Performance



Figure 2. - Output Power and Drain Efficiency vs Frequency CGHV40180F-TB



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CGHV40180F Rev 1.3



CGHV40180F Typical Performance



Figure 4. - Simulated Maximum Available Gain and K-factor of the CGHV40180F $V_{_{\rm DD}}$ = 50 V, I $_{_{\rm DO}}$ = 1.0 A



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CGHV40180F Power Dissipation De-rating Curve



Figure 5. - Transient Power Dissipation De-rating Curve

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CGHV40180F-AMP Application Circuit Schematic



CGHV40180F-AMP Application Circuit



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CGHV40180F Rev 1.3



CGHV40180F-AMP Application Circuit Bill of Materials

Designator	Description	Qty
R11	RES, 1/16W, 0603, 1%, 10.0 OHMS	1
R10	RES, 1/16W, 0603, 1%, 511 OHMS	1
C29	CAP, 33UF, 20%, G CASE	1
C28	CAP 1.0UF, 100V, ±10%, X7R, 1210	1
C17	CAP, 510pF, NPO, 5%, 100V, 0603	1
C26	CAP, 470pF, NPO, 5%, 250V, ATC800B	1
C19	CAP, 10UF, 16V TANTALUM, 2312	1
C14, C15	CAP, 12.0pF, ±5%, 0603, ATC600S	2
C1, C16	CAP, 27pF, ±5%, 0603, ATC600S	2
C10	CAP, 4.7pF, ±0.1pF, 0603, ATC600S	1
C11	CAP, 6.8pF, ±0.25pF, 0603, ATC600S	1
C12, C13	CAP, 8.2pF, ±0.25 pF, 0603, ATC600S	2
C18, C27	CAP, 33000pF, 0805, 100V, X7R	2
C20	CAP, 10pF, ±1%, 250V, 0805, ATC600F	2
C25	CAP, 20pF, ±5%, 250V, 0805, ATC600F	1
C24	CAP, 27pF, ±5%, 250V, 0805, ATC600F	1
C23	CAP, 3.0pF, ±0.1pF, 250V, 0805, ATC600F	2
C22	CAP, 6.2pF, ±0.1pF, 250V, 0805, ATC600F	1
C21	CAP, 8.2pF, ±0.1pF, 250V, 0805 ATC600F	1
-	PCB ROGERS HTC6035, 0.020 THK, ER 3.60	1
J1,J2	CONN, SMA, PANEL MOUNT JACK, FLANGE, 4 HOLE BLUNT POST	2
J3	HEADER RT>PLZ .1CEN LK 9POS	1
L10	INDUCTOR, CHIP, 6.8nH, 5%, 0603 SMT, DIGIKEY 712-1432-1-ND	1
Q1	CGHV40180	1

CGHV40180F-AMP Demonstration Amplifier Circuit



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Source and Load Impedances



Frequency (MHz)	Z Source	Z Load
50	23.7 + J25.9	7.6 + J0.6
150	7.4 + J8.3	8.1 + J0.7
250	4.2 +J7.9	7.9 + J2.2
500	1.4 + J1.5	4.7 + J2.7
750	1.0 + J0.0	3.9 + J2.3
1000	0.7 + J1.1	4.0 + J1.8

Note 1. $V_{_{\rm DD}}$ = 50 V, $I_{_{\rm DQ}}$ = 1.0A in the 440223 package.

Note 2. Optimized for Power Gain, $\mathsf{P}_{_{\mathsf{SAT}}}$ and Drain Efficiency

Note 3. When using this device at low frequency, series resistor should be used to maintain amplifier stability

Electrostatic Discharge (ESD) Classifications

Parameter	Symbol	Class	Test Methodology
Human Body Model	НВМ	1A (> 250 V)	JEDEC JESD22 A114-D
Charge Device Model	CDM	2 (125 V to 250 V)	JEDEC JESD22 C101-C



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Product Dimensions CGHV40180F (Package Type – 440223)



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NOTES: 1. DIMENSIONING AND TOLERANICING PER ANSI Y14.5M, 1982.

2. CONTROLLING DIMENSION: INCH.

3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020' BEYOND EDGE OF LID.

 LID MAY BE MISALIGNED TO THE BODY OF THE PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.
 ALL PLATED SURFACES ARE NI/AU

	INC	HES	MILLIM	IETERS
DIM	MIN	MAX	MIN	MAX
A	0.225	0.235	5.72	5.97
В	0.004	0.006	0.10	0.15
С	0.145	0.165	3.68	4.19
D	0.077	0.087	1.96	2.21
E	0.355	0.365	9.02	9.27
F	0.210	0.220	5.33	5.59
G	0.795	0.805	20.19	20.45
н	0.400	0.460	10.16	11.68
J	ø.	130	3.3	50
k	0.5	62	14.	27

PIN 1. GATE PIN 2. DRAIN PIN 3. SOURCE



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Part Number System



Parameter	Value	Units
Upper Frequency ¹	4.0	GHz
Power Output	100	W
Package	Flange	-

Table 1.

Note¹: Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

Character Code	Code Value
А	0
В	1
С	2
D	3
E	4
F	5
G	б
Н	7
J	8
К	9
Examples:	1A = 10.0 GHz 2H = 27.0 GHz

Table 2.

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Product Ordering Information

Order Number	Description	Unit of Measure	Image
CGHV40180F	GaN HEMT	Each	CREATING ST
CGHV40180F-TB	Test board without GaN HEMT	Each	
CGHV40180F-AMP	Test board with GaN HEMT (flanged) installed	Each	

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